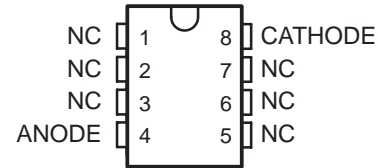


LM285-2.5, LM385-2.5, LM385B-2.5 MICROPOWER VOLTAGE REFERENCES

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- Operating Current Range . . . 20 μ A to 20 mA
- 1.5% and 3% Initial Voltage Tolerance
- Reference Impedance
 - LM385 . . . 1 Ω Max at 25°C
 - All Devices . . . 1.5 Ω Max Over Full Temperature Range
- Very Low Power Consumption
- Applications
 - Portable Meter References
 - Portable Test Instruments
 - Battery-Operated Systems
 - Current-Loop Instrumentation
 - Panel Meters
- Interchangeable With Industry-Standard LM285-2.5 and LM385-2.5

LM285-2.5 . . . D PACKAGE
LM385-2.5, LM385B-2.5 . . . D OR PW PACKAGE
(TOP VIEW)



NC – No internal connection

LM285-2.5, LM385-2.5, LM385B-2.5 . . . LP PACKAGE
(TOP VIEW)



NC – No internal connection

description/ordering information

These micropower two-terminal band-gap voltage references operate over a 20- μ A to 20-mA current range and feature exceptionally low dynamic impedance and good temperature stability. On-chip trimming provides tight voltage tolerance. The band-gap reference for these devices has low noise and long-term stability.

ORDERING INFORMATION

T _A	V _Z TOLERANCE	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	3%	SOIC (D)	Tube of 75	LM385D-2-5	385-25
			Reel of 2000	LM385DR-2-5	
		TO226/TO-92 (LP)	Tube of 1000	LM385LP-2-5	385-25
			Reel of 2000	LM385LPR-2-5	
		TSSOP (PW)	Tube of 150	LM385PW-2-5	385-25
			Reel of 2000	LM385PWR-2-5	
	1.5%	SOIC (D)	Tube of 75	LM385BD-2-5	385B25
			Reel of 2000	LM385BDR-2-5	
		TO226/TO-92 (LP)	Tube of 1000	LM385BLP-2-5	385-25
			Reel of 2000	LM385BLPR-2-5	
TSSOP (PW)		Tube of 150	LM385BPW-2-5	385B25	
		Reel of 2000	LM385BPWR-2-5		
–40°C to 85°C	1.5%	SOIC (D)	Tube of 75	LM285D-2-5	285-25
			Reel of 2000	LM285DR-2-5	
		TO226/TO-92 (LP)	Tube of 1000	LM285LP-2-5	285-25
			Reel of 2000	LM285LPR-2-5	285-25

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
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LM285-2.5, LM385-2.5, LM385B-2.5 MICROPOWER VOLTAGE REFERENCES

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description/ordering information (continued)

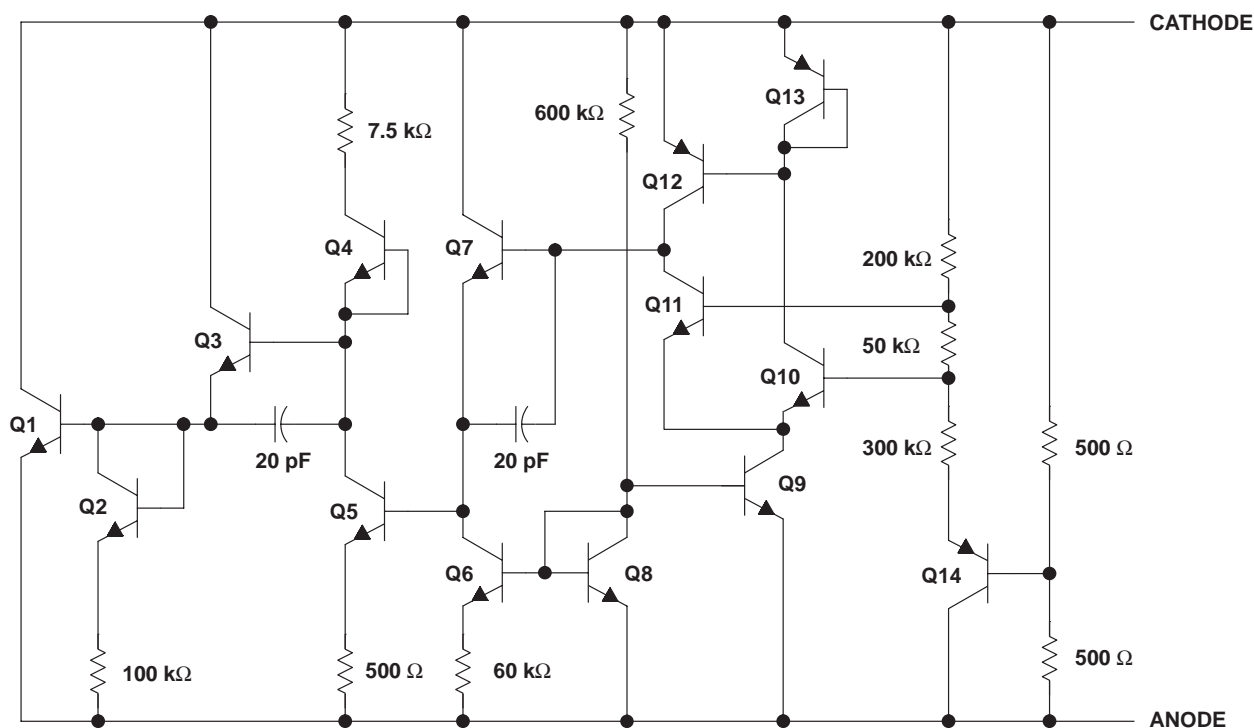
The design makes these devices exceptionally tolerant of capacitive loading and, thus, easier to use in most reference applications. The wide dynamic operating temperature range accommodates varying current supplies, with excellent regulation.

The extremely low power drain of this series makes them useful for micropower circuitry. These voltage references can be used to make portable meters, regulators, or general-purpose analog circuitry, with battery life approaching shelf life. The wide operating current range allows them to replace older references with tighter-tolerance parts.

symbol



schematic



NOTE A: All component values shown are nominal.

LM285-2.5, LM385-2.5, LM385B-2.5 MICROPOWER VOLTAGE REFERENCES

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Reverse current, I_R	30 mA
Forward current, I_F	10 mA
Package thermal impedance, θ_{JA} (see Notes 1 and 2): D package	97°C/W
LP package	140°C/W
PW package	149°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Maximum power dissipation is a function of $T_{J(max)}$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_{J(max)} - T_A)/\theta_{JA}$. Operation at the absolute maximum T_J of 150°C can affect reliability.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		MIN	MAX	UNIT
I_Z	Reference current	0.02	20	mA
T_A	Operating free-air temperature range	LM285-2.5	–40	85
		LM385-2.5, LM385B-2.5	0	70

electrical characteristics at specified free-air temperature

PARAMETER		TEST CONDITIONS	T _A [‡]	LM285-2.5			LM385-2.5			LM385B-2.5			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
V _Z	Reference voltage	I _Z = 20 μA to 20 mA	25°C	2.462	2.5	2.538	2.425	2.5	2.575	2.462	2.5	2.538	V
α _{VZ}	Average temperature coefficient of reference voltage [§]	I _Z = 20 μA to 20 mA	Full range	±20			±20			±20			ppm/°C
ΔV _Z	Change in reference voltage with current	I _Z = 20 μA to 1 mA	25°C	1			2			2			mV
			Full range	1.5			2			2			
		I _Z = 1 mA to 20 mA	25°C	10			20			20			
			Full range	30			30			30			
ΔV _Z /Δt	Long-term change in reference voltage	I _Z = 100 μA	25°C	±20			±20			±20			ppm/khr
I _Z (min)	Minimum reference current		Full range	8 20			8 20			8 20			μA
z _Z	Reference impedance	I _Z = 100 μA	25°C	0.2 0.6			0.4 1			0.4 1			Ω
			Full range	1.5			1.5			1.5			
V _n	Broadband noise voltage	I _Z = 100 μA, f = 10 Hz to 10 kHz	25°C	120			120			120			μV

[‡] Full range is 0°C to 70°C for the LM385-2.5 and LM385B-2.5, and –40°C to 85°C for the LM285-2.5.

[§] The average temperature coefficient of reference voltage is defined as the total change in reference voltage divided by the specified temperature range.



LM285-2.5, LM385-2.5, LM385B-2.5 MICROPOWER VOLTAGE REFERENCES

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TYPICAL CHARACTERISTICS†

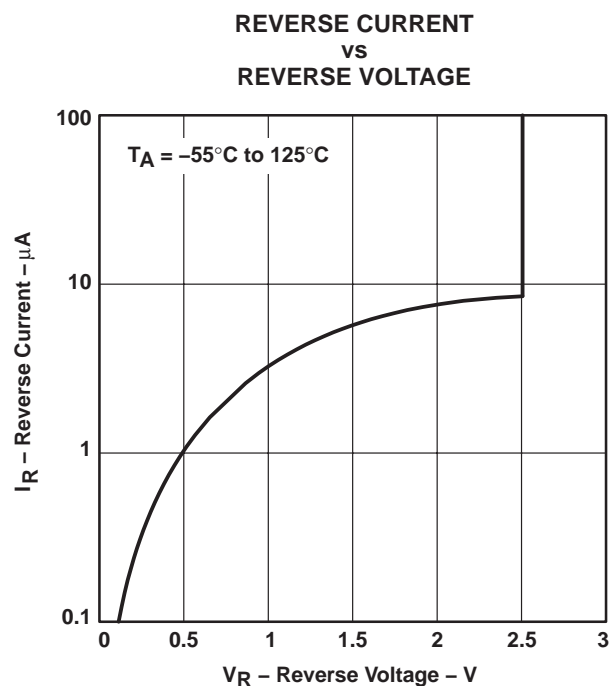


Figure 1

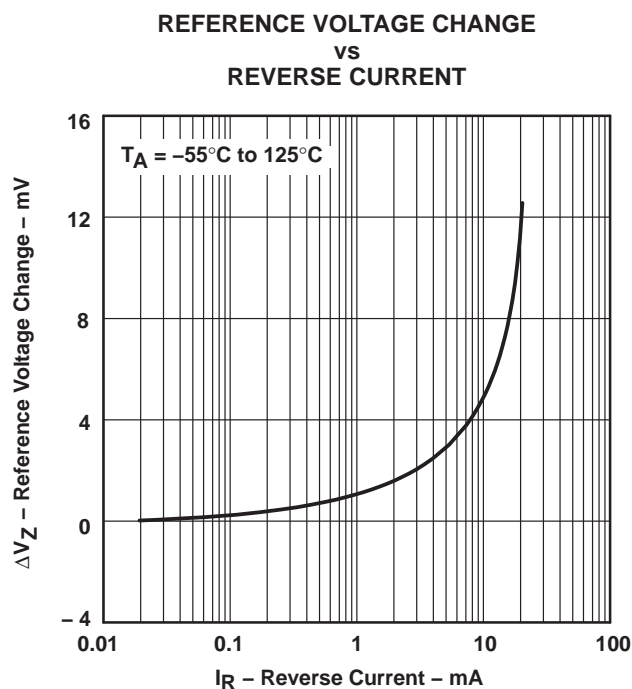


Figure 2

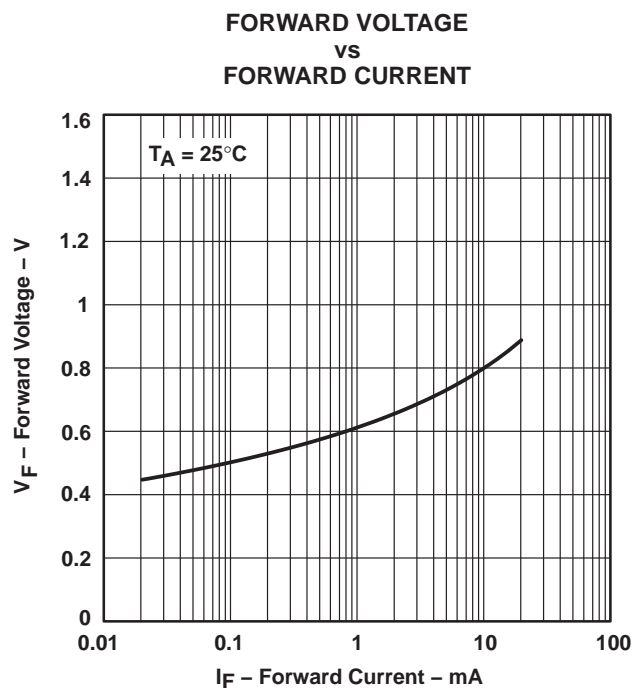


Figure 3

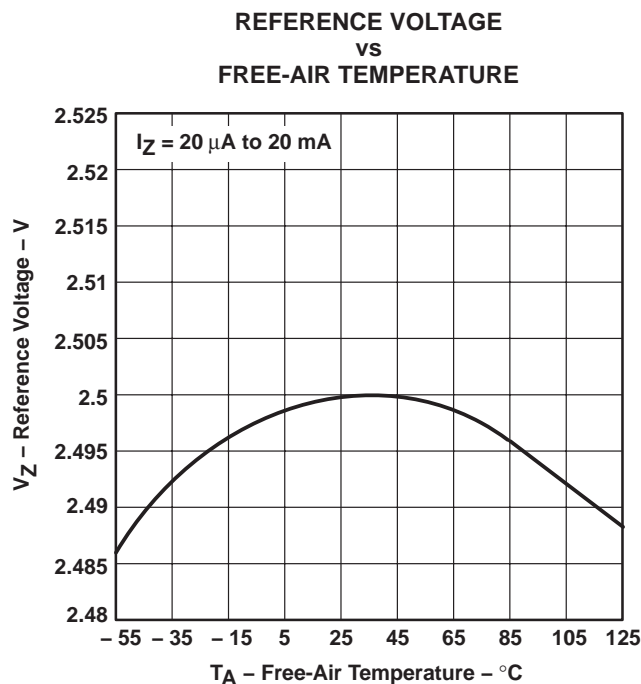


Figure 4

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS†

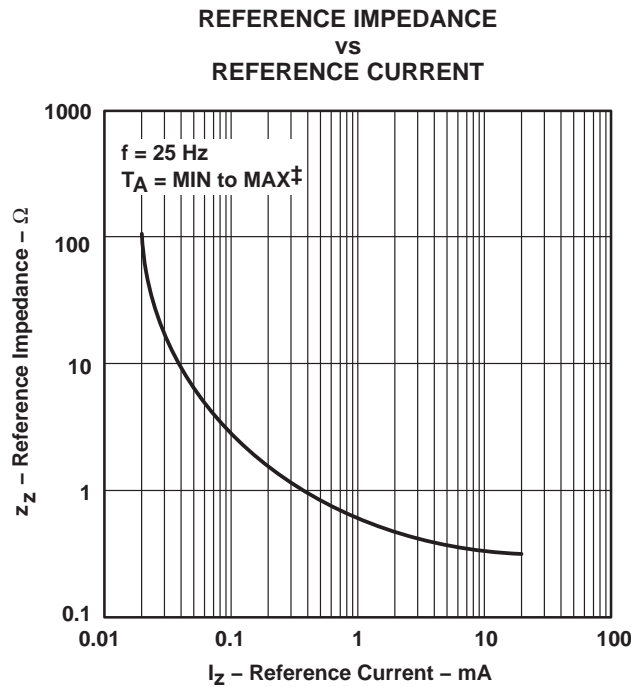


Figure 5

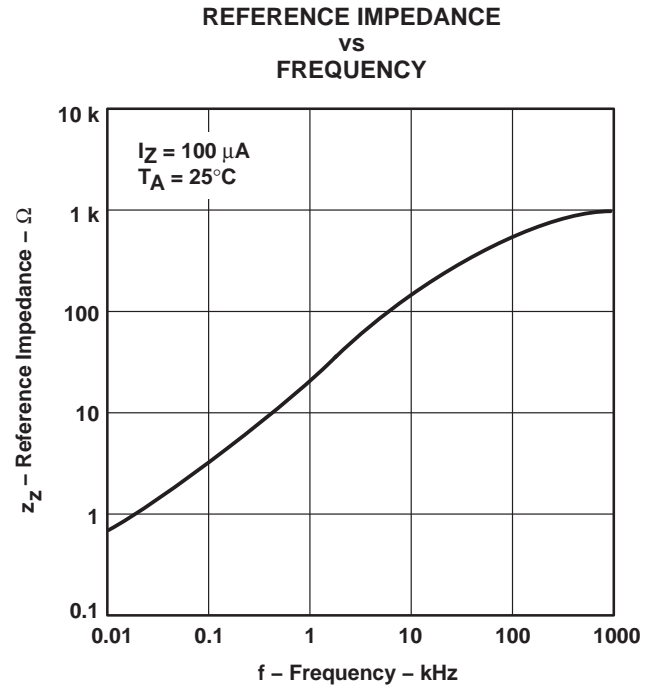


Figure 6

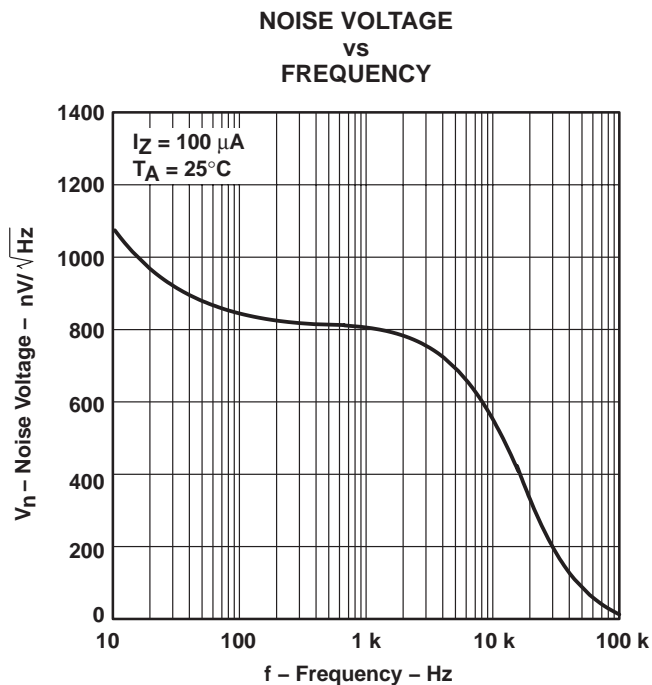


Figure 7

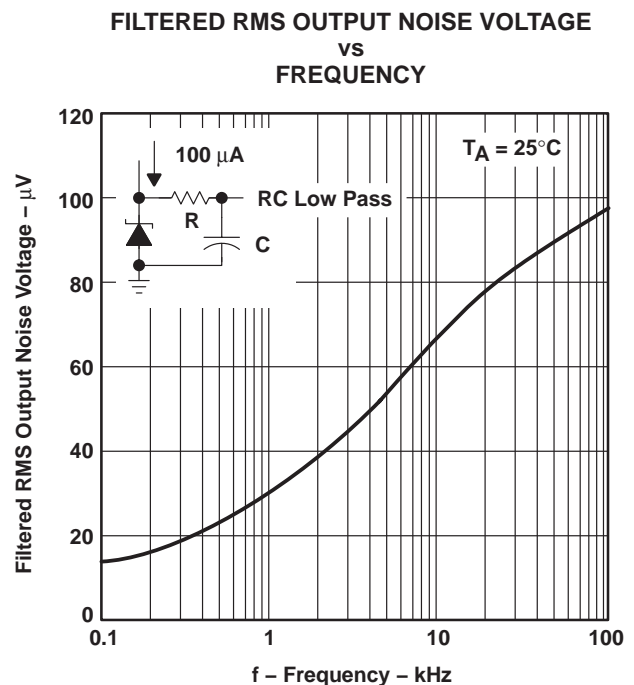


Figure 8

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

‡ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

LM285-2.5, LM385-2.5, LM385B-2.5 MICROPOWER VOLTAGE REFERENCES

SLVS023J – JANUARY 1989 – REVISED MARCH 2005

TYPICAL CHARACTERISTICS†

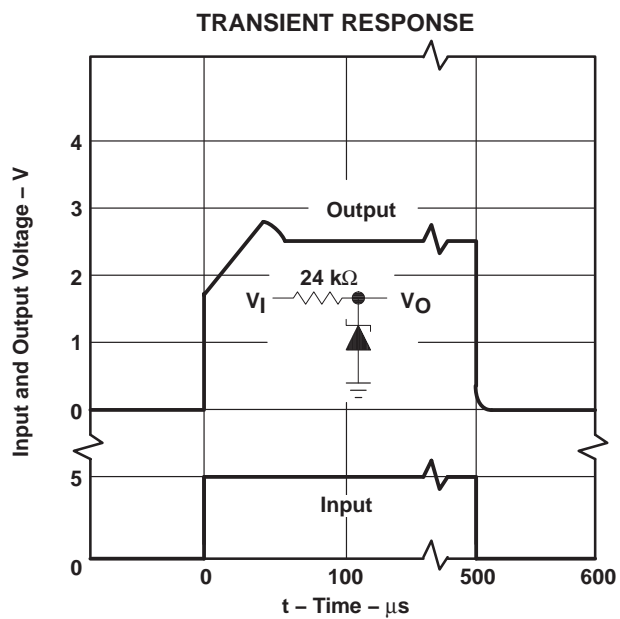


Figure 9

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

The circuit diagram shows a power supply section labeled "Two Mercury Cells 2.6 V". The positive terminal is connected to a node from which a $3.3\text{ k}\Omega$ resistor leads down to the negative rail. This same node also branches off to the non-inverting input ($V+$) of an LM334 current source. The negative rail is connected to the cathode of an LM385-2.5 precision centred diode. The anode of this diode is connected to a node between a $200\text{ k}\Omega \pm 1\%$ resistor and a $20\text{ k}\Omega$ resistor. The other end of the $20\text{ k}\Omega$ resistor is connected to the negative rail. A wiper symbol labeled "CW" indicates an adjustable connection point on the $20\text{ k}\Omega$ resistor. The junction between the $200\text{ k}\Omega$ and $20\text{ k}\Omega$ resistors is also connected to the negative input ($V-$) of the LM334. The LM334's $V+$ pin is also connected to a $412\text{ }\Omega \pm 1\%$ resistor, which is connected to the negative rail. The output of the LM334, labeled "R", passes through a $2.00\text{ k}\Omega \pm 1\%$ resistor to another wiper symbol labeled "CW". This second wiper is connected to the positive input of a Type K thermocouple. The other end of the thermocouple is connected to the negative rail. The negative rail is also connected to one terminal of a "Meter". The other terminal of the meter is connected to the negative input ($V-$) of the LM334. A label $I_O \approx 60\text{ }\mu\text{A}$ is placed near the top left of the circuit.

Figure 10. Thermocouple Cold-Junction Compensator

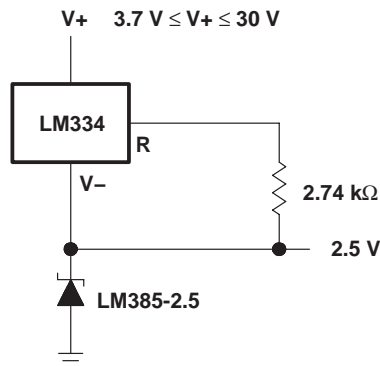


Figure 11. Operation Over a Wide Supply Range

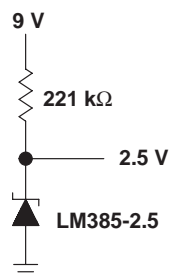


Figure 12. Reference From a 9-V Battery

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LM285D-2-5	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM285DE4-2-5	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM285DR-2-5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM285DRE4-2-5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM285LP-2-5	ACTIVE	TO-92	LP	3	1000	TBD	CU SNPB	N / A for Pkg Type
LM285LPE3-2-5	ACTIVE	TO-92	LP	3	1000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
LM285LPR-2-5	ACTIVE	TO-92	LP	3	2000	TBD	CU SNPB	N / A for Pkg Type
LM285LPRE3-2-5	ACTIVE	TO-92	LP	3	2000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
LM385BD-2-5	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385BDE4-2-5	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385BDR-2-5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385BDRE4-2-5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385BLP-2-5	ACTIVE	TO-92	LP	3	1000	TBD	CU SNPB	N / A for Pkg Type
LM385BLPE3-2-5	ACTIVE	TO-92	LP	3	1000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
LM385BLPR-2-5	ACTIVE	TO-92	LP	3	2000	TBD	CU SNPB	N / A for Pkg Type
LM385BLPRE3-2-5	ACTIVE	TO-92	LP	3	2000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
LM385BPW-2-5	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385BPWE4-2-5	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385BPWR-2-5	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385BPWRE4-2-5	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385D-2-5	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385DE4-2-5	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385DR-2-5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385DRE4-2-5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385LP-2-5	ACTIVE	TO-92	LP	3	1000	TBD	CU SNPB	N / A for Pkg Type
LM385LPE3-2-5	ACTIVE	TO-92	LP	3	1000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
LM385LPR-2-5	ACTIVE	TO-92	LP	3	2000	TBD	CU SNPB	N / A for Pkg Type

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LM385LPRE3-2-5	ACTIVE	TO-92	LP	3	2000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
LM385PW-2-5	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385PWE4-2-5	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385PWR-2-5	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM385PWRE4-2-5	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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D (R-PDSO-G8)

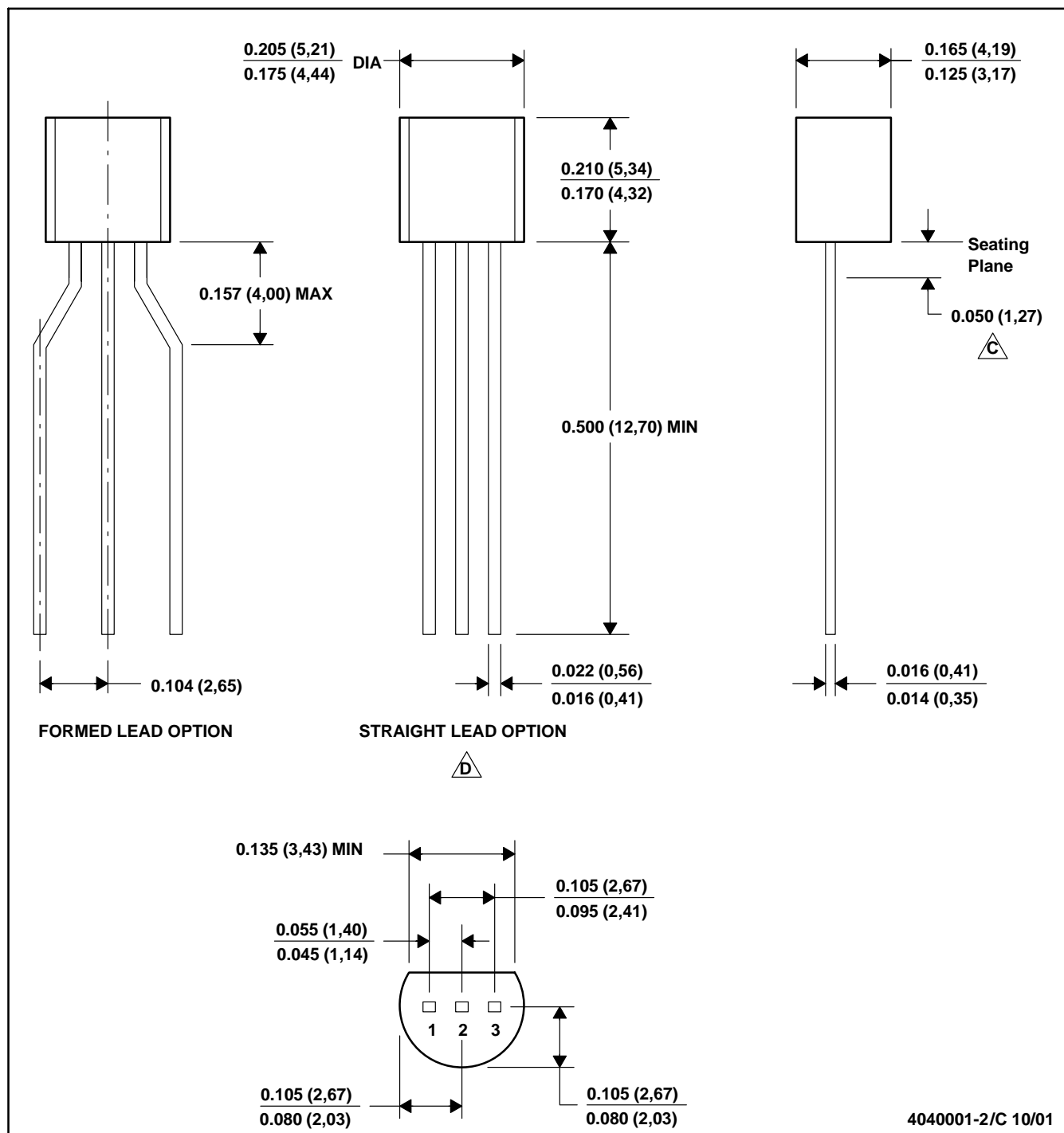
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-012 variation AA.

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



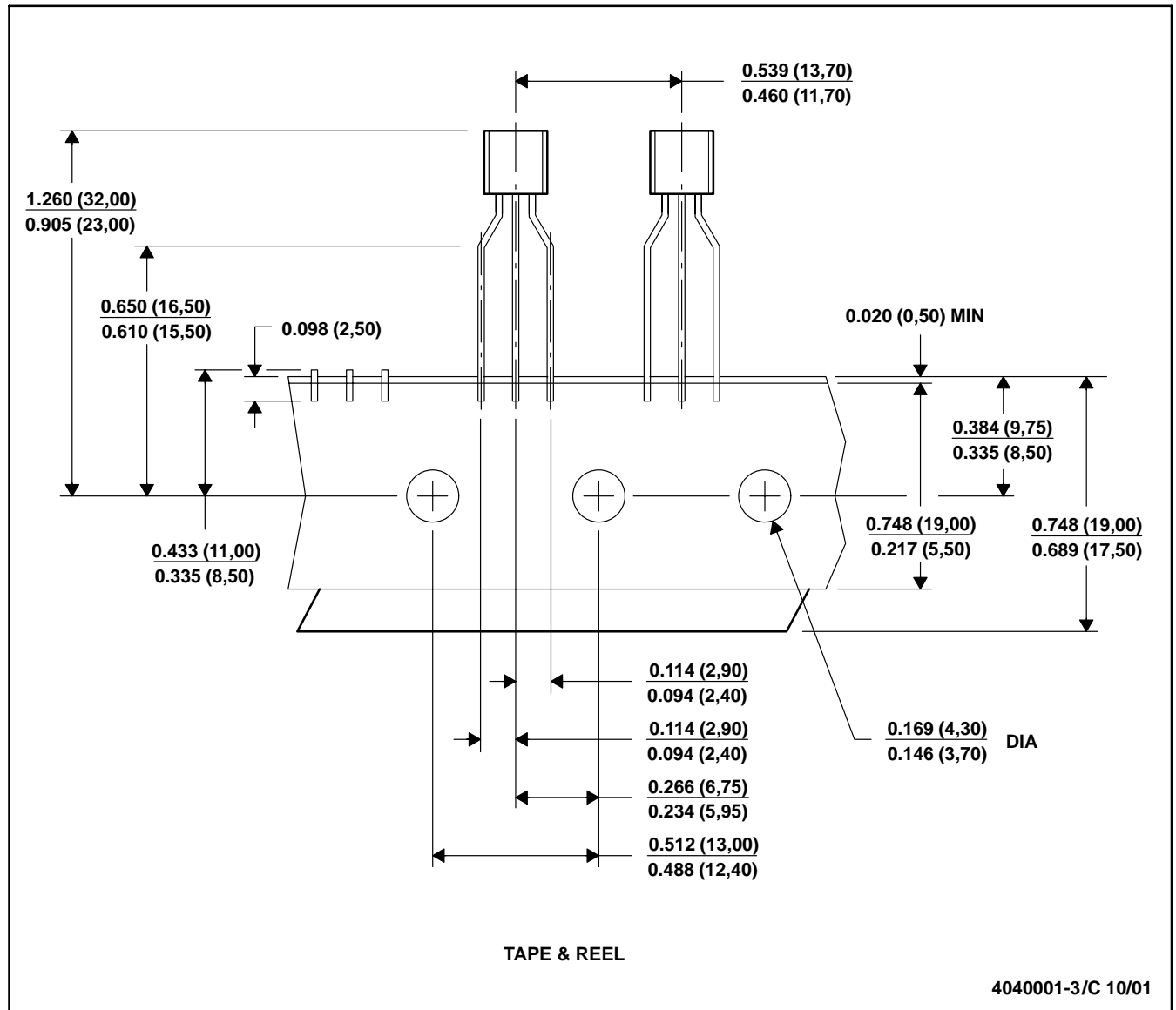
- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 $\triangle C$ Lead dimensions are not controlled within this area
 $\triangle D$ Falls within JEDEC TO -226 Variation AA (TO-226 replaces TO-92)
 E. Shipping Method:
 Straight lead option available in bulk pack only.
 Formed lead option available in tape & reel or ammo pack.

MECHANICAL DATA

MSOT002A – OCTOBER 1994 – REVISED NOVEMBER 2001

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE

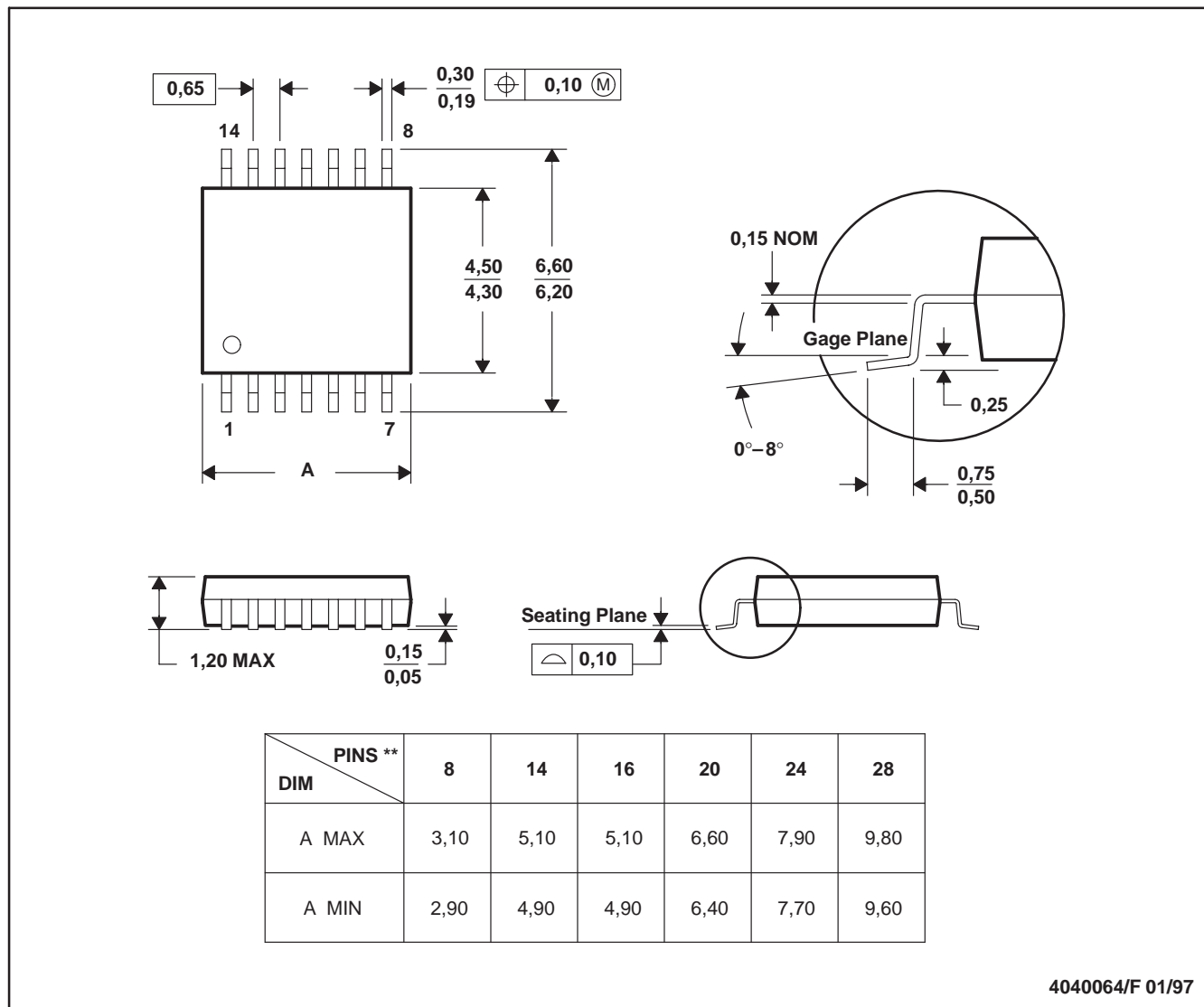


- NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Tape and Reel information for the Format Lead Option package.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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